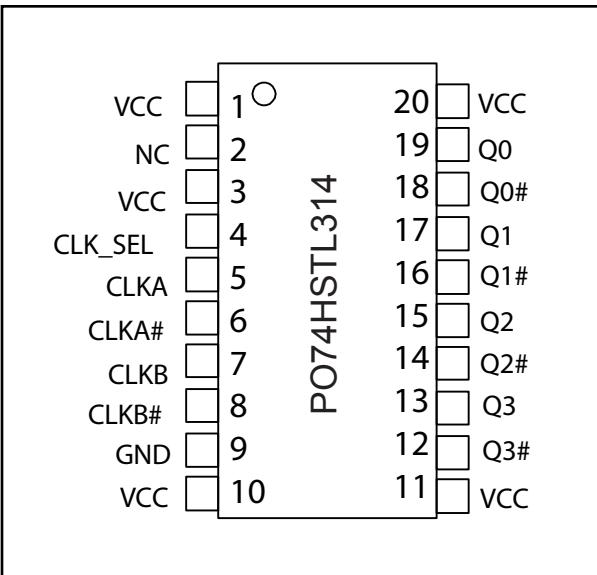
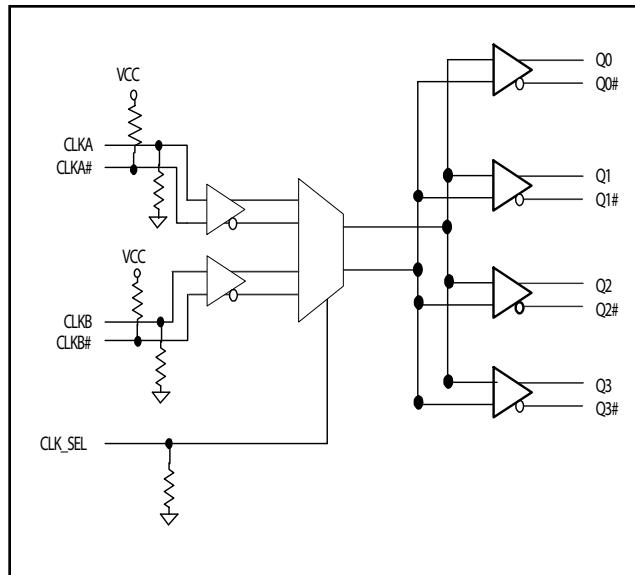


**500MHz HSTL Potato Chip**

<b>FEATURES:</b>	<b>DESCRIPTION:</b>
<ul style="list-style-type: none"> <li>. Patented Technology</li> <li>. Four HSTL differential outputs</li> <li>. The two pair of LVDS/LVPECL/HSTL/ differential or single-ended inputs</li> <li>. Hot-swappable/-insertable</li> <li>. Operating frequency up to 500MHz with 2pf load</li> <li>. Operating frequency up to 480MHz with 5pf load</li> <li>. Operating frequency up to 400MHz with 15pf load</li> <li>. Very low output pin to pin skew &lt; 80ps</li> <li>. Very low pulse skew &lt; 80ps</li> <li>. 2.8-ns propagation delay (typical)</li> <li>. 2.3V to 3.6V power supply</li> <li>. Industrial temperature range: -40°C to 85°C</li> <li>. 20-pin 209 mil SSOP package</li> </ul>	<p>The PO74HSTL314 is a low-skew, 2-to-4 differential fanout buffer targeted to meet the requirements of high-performance clock and data distribution applications. The device is implemented on 0.35um CMOS technology and has a fully differential internal architecture that is optimized to achieve low signal skews at operating frequencies of up to 500MHz .</p> <p>The device features two differential input paths that are multiplexed plexed internally. This mux is controlled by the CLK_SEL pin. The PO74HSTL314 may function not only as a differential clock buffer but also as a signal-level translator and fanout on HSTL or LVCMOS / LVTTL single-ended signal to four HSTL differential loads. Since the PO74HSTL314 introduces negligible jitter to the timing budget, it is the ideal choice for distributing high frequency, high precision clocks across back-planes and boards in communication systems.</p>

**Pin Configuration****Logic Block Diagram**

**500MHz HSTL Potato Chip****Pin Definitions**

Pin	Name	I/O	Type	Description
1, 10, 11, 20, 3	VCC	VCC	Power	Power supply, positive connection
2	NC			No connect
4	CLK_SEL	I,PD	LVC MOS	Input clock select with pull down resistor
5	CLKA	I,PD	LVDS, PECL, HSTL	Default differential clock input
6	CLKA#	I,PU	LVDS, PECL, HSTL	Input clock select with pull up resistor
7	CLKB	I,PD	LVDS, PECL, HSTL	Input clock select with pull down resistor
8	CLKB#	I,PU	LVDS, PECL, HSTL	Input clock select with pull up resistor
9	VEE	GND	Power	Power Ground
18, 16, 14, 12	Q[0:3]#	O	HSTL	Complement output
19, 17, 15, 13	Q[0:3]	O	HSTL	True output

**Function Table**

Control	
CLK_SEL	
0	CLKA, CLKA# input pair is active (Default condition with no connection to pin) CLKA can be driven with LVDS, ECL, PECL, HSTL or TTL compatible signals with respective power configurations
1	CLKB, CLKB# input pair is active CLKB can be driven with LVDS, ECL, PECL, HSTL or TTL compatible signals with respective power configurations

**Pin Characteristics**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$C_{IN}$	Input Capacitance			4		pF
$R_{PULLUP}$	Input Pullup Resistor			88		KΩ
$R_{PULLDOWN}$	Input Pulldown Resistor			88		KΩ

**500MHz HSTL Potato Chip****Maximum Ratings**

Description	Max	Unit
Storage Temperature	-65 to 150	°C
Operation Temperature	-40 to 85	°C
Operation Voltage	-0.5 to +4.6	V
Input Voltage	-0.5 to +5.5	V
Output Voltage	-0.5 to Vcc+0.5	V

**Note:**

stresses greater than listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability specification is not implied.

**DC Electrical Characteristics**

Symbol	Description	Test Conditions	Min	Typ	Max	Unit
<b>VOH</b>	Output High voltage	Vcc=3V Vin=VIH or VIL, IOH= -12mA	<b>2.4</b>	<b>3</b>	-	<b>V</b>
<b>VOL</b>	Output Low voltage	Vcc=3V Vin=VIH or VIL, IOH=12mA	-	<b>0.3</b>	<b>0.5</b>	<b>V</b>
<b>VIK</b>	Clamp diode voltage	Vcc = Min. And IIN = -18mA	-	<b>-0.7</b>	<b>-1.2</b>	<b>V</b>
<b>IOFF</b>	Power off output leakage current	Vcc = 0V. Vi or Vo = 0V to 5.5V	-	-	<b>±5</b>	<b>uA</b>

Multiple Supplies: The Voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required.

**Notes:**

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at Vcc = 3.3V, 25 °C ambient.
3. This parameter is guaranteed but not tested.
4. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
5. VoH = Vcc – 0.6V at rated current



## 500MHz HSTL Potato Chip

## Power Supply Characteristics

Symbol	Description	Test Conditions (1)	Min	Typ	Max	Unit
<b>I<sub>ccQ</sub></b>	Quiescent Power Supply Current	V <sub>CC</sub> =Max, V <sub>IN</sub> =V <sub>CC</sub> or GND	-	<b>0.1</b>	<b>30</b>	<b>uA</b>

## Notes:

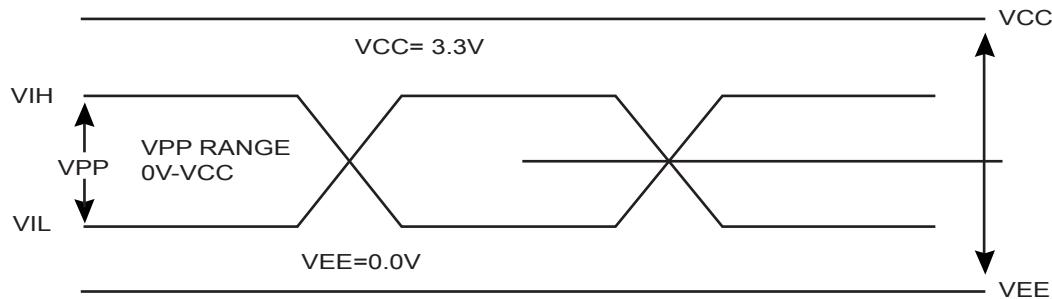
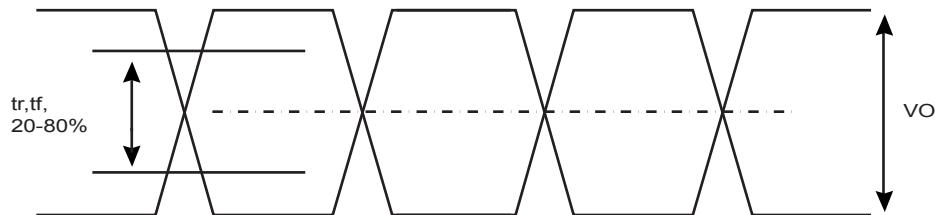
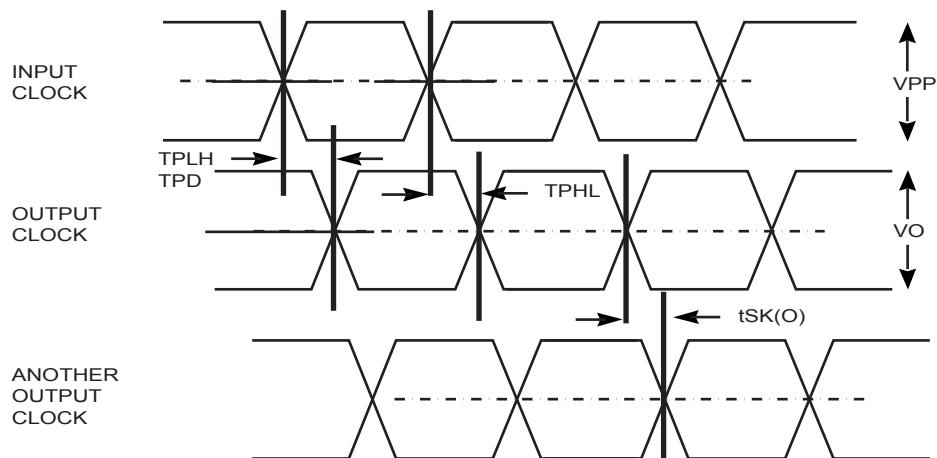
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2. Typical values are at V<sub>CC</sub> = 3.3V, 25°C ambient.
3. This parameter is guaranteed but not tested.
4. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

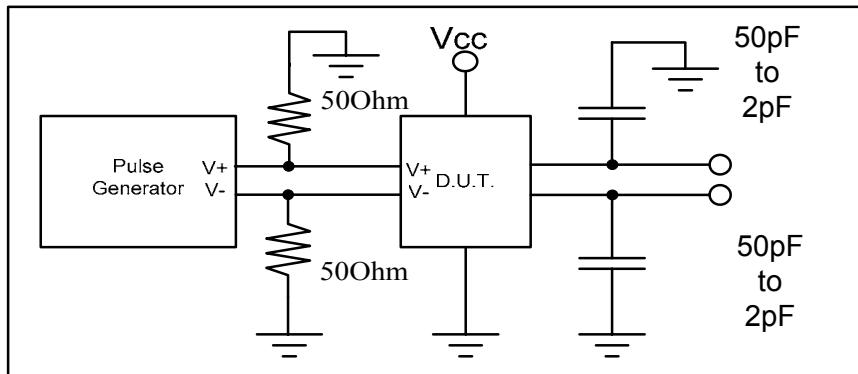
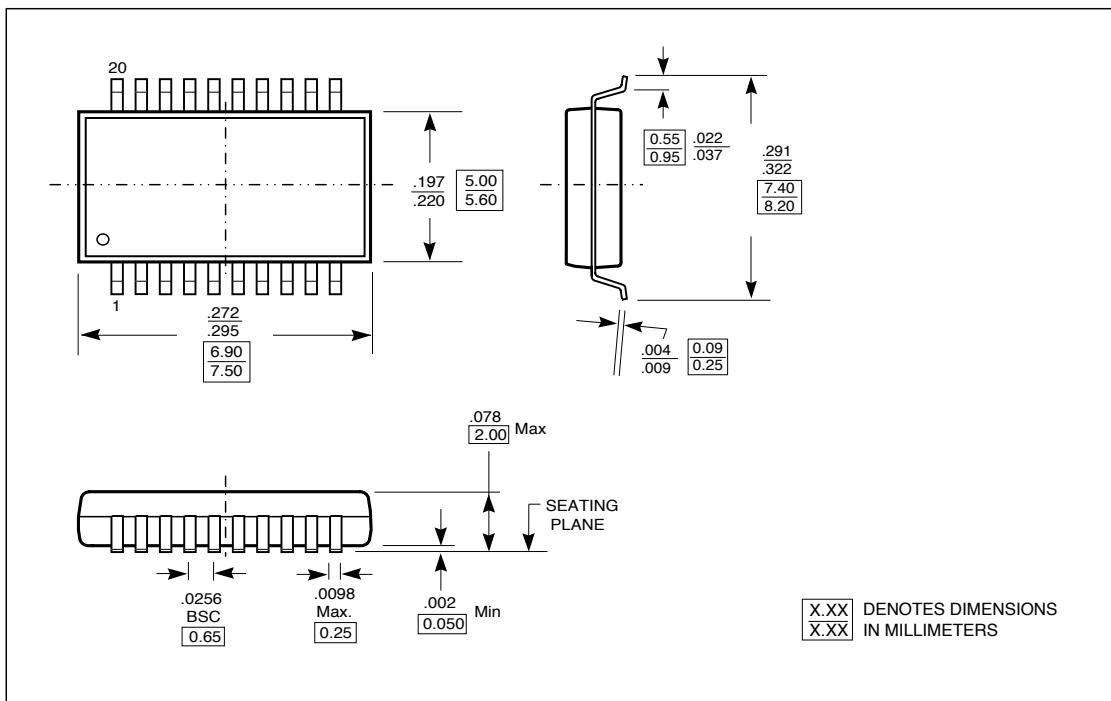
## Switching Characteristics

Symbol	Description	Test Conditions (1)	Max	Unit
<b>t<sub>PD</sub></b>	Propagation Delay CLKA or CLKB to Output pair	CL = 15pF	<b>3.2</b>	<b>ns</b>
<b>t<sub>r/tf</sub></b>	Rise/Fall Time	0.8V – 2.0V	<b>0.8</b>	<b>ns</b>
<b>tsk(p)</b>	Pulse Skew (Same Package)	CL = 15pF, 125MHz	<b>80</b>	<b>ps</b>
<b>tsk(o)</b>	Output Pin to Pin Skew (Same Package)	CL = 15pF, 125MHz	<b>80</b>	<b>ps</b>
<b>tsk(pp)</b>	Output Skew (Different Package)	CL = 15pF, 125MHz	<b>350</b>	<b>ps</b>
<b>f<sub>max</sub></b>	Input Frequency	CL = 15pF	<b>400</b>	<b>MHz</b>
<b>f<sub>max</sub></b>	Input Frequency	CL = 5pF	<b>480</b>	<b>MHz</b>
<b>f<sub>max</sub></b>	Input Frequency	CL = 2pF	<b>500</b>	<b>MHz</b>

## Notes:

1. See test circuits and waveforms.
2. t<sub>PLH</sub>, t<sub>PHL</sub>, tsk(p), and tsk(o) are production tested. All other parameters guaranteed but not production tested.
3. Airflow of 1m/s is recommended for frequencies above 133MHz

**500MHz HSTL Potato Chip****Test Waveforms****FIGURE 1. LVDS/ PECL/ ECL/ HSTL /DIFFERENTIAL INPUT WAVEFORM DEFINITIONS****FIGURE 2. HSTL/HSTL OUTPUT****FIGURE 3. Propogation Delay, Output pulse skew, and output-to-output skew for both CLKA or CLKB to output pair**

**500MHz HSTL Potato Chip****Test Circuit****Packaging Mechanical Drawing: 20 pin SSOP**

**500MHz HSTL Potato Chip****IC Ordering Information**

Ordering Code		Package		Top-Marking	T <sub>A</sub>
PO74HSTL314ASU	for Tube	20pin 209mil SSOP	Pb-free & Green	PO74HSTL314AS	-40°C to 85°C
PO74HSTL314ASR	for Tape & Reel	20pin 209mil SSOP	Pb-free & Green	PO74HSTL314AS	-40°C to 85°C

**IC Package Information**

PACKAGE CODE	PACKAGE TYPE	TAPE WIDTH (mm)	TAPE PITCH (mm)	TAPE & REEL PIN 1 LOCATION	TAPE TRAILER LENGTH	QTY PER TAPE	TAPE LEADER LENGTH	QTY PER TUBE
SS	20-pin 209mil SSOP	16	12	Top Left Corner	26 (12")	2000	43 (20")	66